

Electronic Transport Processes in Heavily Doped Uncompensated and Compensated Silicon as Probed by the Thermoelectric Power

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Abstract

The thermoelectric power S and electrical resistivity ρ , measured between 1.5 and 30 K, of just insulating, heavily doped Si show distinct differences between uncompensated and compensated samples. $S(T)$ of Si:P exhibits a sign change from $S < 0$ to $S > 0$ with decreasing T at a temperature $T_{S=0}$ which increases sharply with decreasing carrier concentration N below $N_0 = 2.78 \times 10^{18} \text{cm}^{-3}$. Below N_0 , $\rho(T)$ shows activated conduction over an energy gap E_2 which has the same N dependence as $T_{S=0}$. This is attributed to the splitting of the two Hubbard bands. In contrast, $S(T)$ of Si:(P, B) is negative in the whole N and T range investigated and $\rho(T)$ shows Efros-Shklovskii variable-range hopping down to the lowest N .